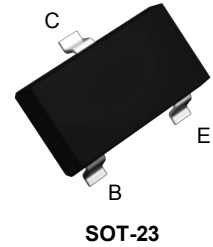


**Features**

- Switching transistor
- Ultra-small surface mount package
- Plastic-Encapsulate transistor



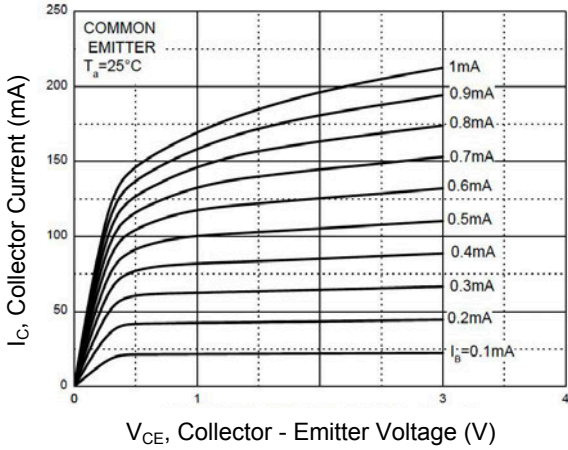
**Absolute Maximum Ratings** ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)

Parameter	Symbol	Max.	Unit
Collector-Base Voltage	$V_{CB0}$	60	V
Collector-Emitter Voltage	$V_{CE0}$	40	V
Emitter-Base Voltage	$V_{EB0}$	6	V
Collector Current-Continuous	$I_C$	600	mA
Collector Power Dissipation	$P_C$	300	mW
Typical Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	417	$^{\circ}\text{C}/\text{W}$
Operating Junction Temperature Range	$T_J$	-55 To +150	$^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	-55 To +150	$^{\circ}\text{C}$

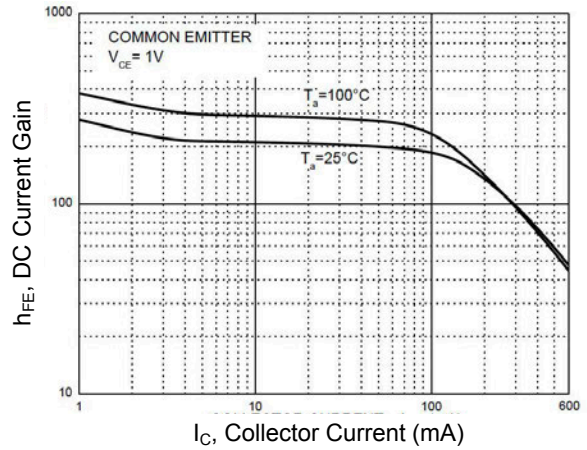
**Electrical Characteristics** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Max.	Unit
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C=100\mu\text{A}$ , $I_E=0$	60	-	V
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C=1\text{mA}$ , $I_B=0$	40	-	V
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E=100\mu\text{A}$ , $I_C=0$	6	-	V
Collector Cut-off Current	$I_{CBO}$	$V_{CB}=50\text{V}$ , $I_E=0$	-	0.1	$\mu\text{A}$
Collector Cut-off Current	$I_{CEX}$	$V_{CE}=35\text{V}$ , $V_{EB}=0.4\text{V}$	-	0.1	$\mu\text{A}$
Emitter Cut-off Current	$I_{EBO}$	$V_{EB}=5\text{V}$ , $I_C=0$	-	0.1	$\mu\text{A}$
DC Current Gain	$h_{FE}^1$	$V_{CE}=1\text{V}$ , $I_C=0.1\text{mA}$	20	-	-
	$h_{FE}^2$	$V_{CE}=1\text{V}$ , $I_C=1\text{mA}$	40	-	-
	$h_{FE}^3$	$V_{CE}=1\text{V}$ , $I_C=10\text{mA}$	80	-	-
	$h_{FE}^4$	$V_{CE}=1\text{V}$ , $I_C=150\text{mA}$	100	300	-
	$h_{FE}^5$	$V_{CE}=2\text{V}$ , $I_C=500\text{mA}$	40	-	-
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=150\text{mA}$ , $I_B=15\text{mA}$	-	0.4	V
		$I_C=500\text{mA}$ , $I_B=50\text{mA}$	-	0.75	V
Base-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=150\text{mA}$ , $I_B=15\text{mA}$	-	0.95	V
		$I_C=500\text{mA}$ , $I_B=50\text{mA}$	-	1.2	V
Transition Frequency	$f_T$	$V_{CE}=10\text{V}$ , $I_C=20\text{mA}$ , $F=100\text{MHz}$	250	-	MHz
Delay Time	$t_d$	$V_{CC}=30\text{V}$ , $V_{BE(off)}=-2\text{V}$ , $I_C=150\text{mA}$ , $I_{B1}=15\text{mA}$	-	15	nS
Rise Time	$t_r$	$I_C=150\text{mA}$ , $I_{B1}=15\text{mA}$	-	20	nS
Storage Time	$t_s$	$V_{CC}=30\text{V}$ , $I_C=150\text{mA}$ , $I_{B1}=I_{B2}=15\text{mA}$	-	225	nS
Fall Time	$t_f$	$I_{B1}=I_{B2}=15\text{mA}$	-	60	nS

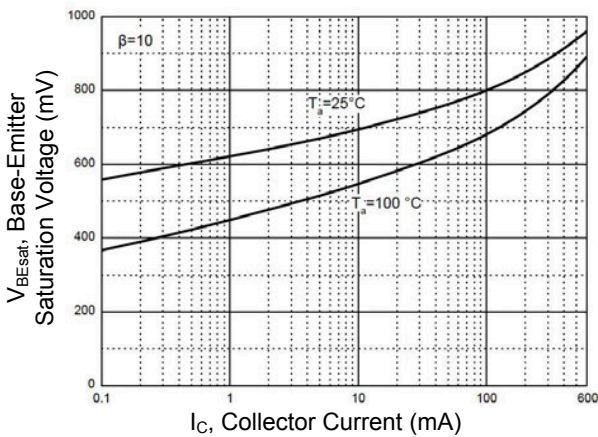
**Ratings and Characteristics Curves** ( $T_A=25^\circ\text{C}$  unless otherwise noted)



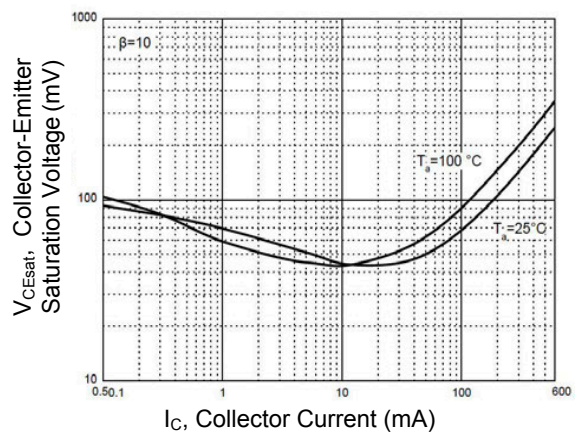
**Figure 1. Static Characteristics**



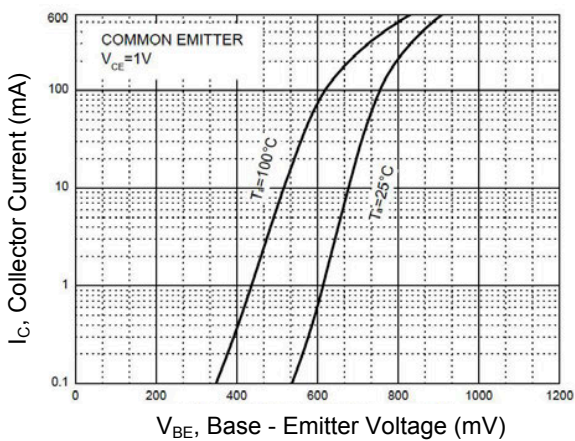
**Figure 2. DC Current Gain vs. Collector Current**



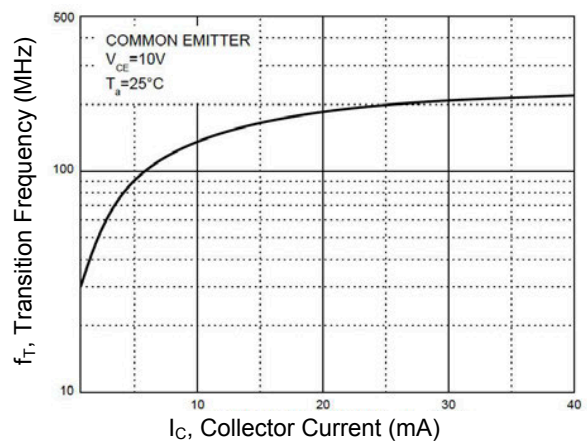
**Figure 3. Base - Emitter Saturation Voltage vs. Collector Current**



**Figure 4. Collector - Emitter Saturation Voltage vs. Collector Current**

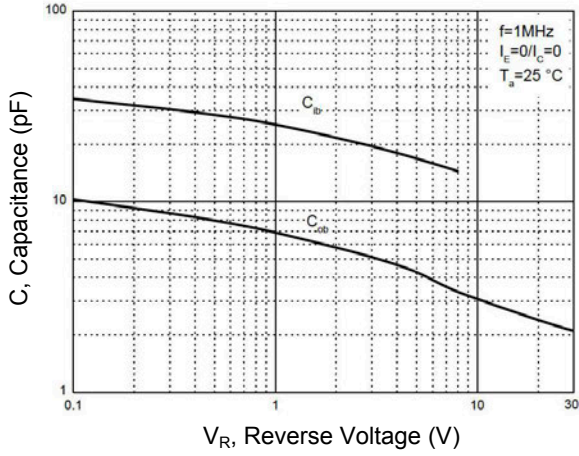


**Figure 5. Collector Current vs. Base - Emitter Voltage**

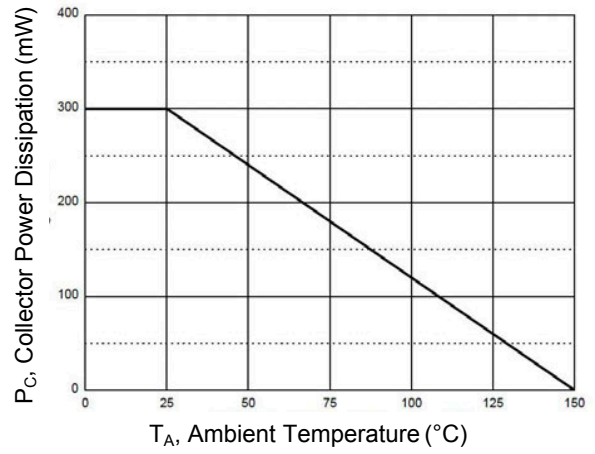


**Figure 6. Transition Frequency vs. Collector Current**

**Ratings and Characteristics Curves** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

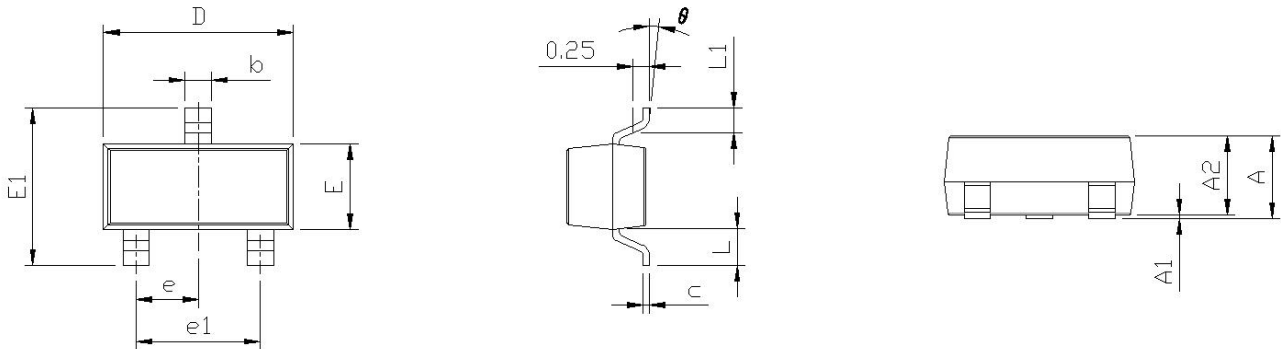


**Figure 7. Capacitance Characteristics**



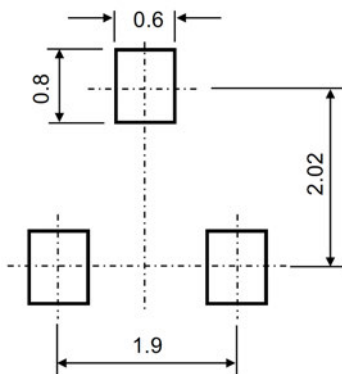
**Figure 8. Power Dissipation vs Ambient Temperature**

**Package Outline Dimensions (SOT-23)**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

**Suggested Pad Layout**



Note:  
 1. Controlling dimension: in millimeters.  
 2. General tolerance:  $\pm 0.05\text{mm}$ .  
 3. The pad layout is for reference purposes only.

**Ordering Information**

Device	Package	Marking	Quantity	HSF Status
MMBT4401	SOT-23	2X	3,000pcs / Reel	RoHS Compliant